

TAI-SAW TECHNOLOGY CO., LTD.

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Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 3.2x2.5 16.00MHz				
TST Part No.: TZ4040AA	4115			
Customer Part No.:				
Customer signature require	ed			
Company:				
Division:				
Approved by :				
	Shaoyen Feng			
Approved by:	Kelly Huang			
Date:	06/30/2022			

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 3.2x2.5 16.00MHz

MODEL NO.: TZ4040AA4115 REV. NO.: 1

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	06/30/22'	N/A	Shaoyen Feng



MODEL NO.: TZ4040AA4115 REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL): Level-1

Lead-free soldering

RoHS Compliant

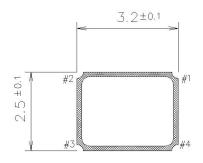
Description and Applications:

Surface mount 3.2mmx2.5mm crystal unit for customer for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

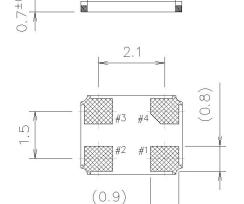
Electrical Specifications:

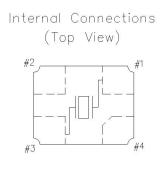
TZ4040AA4115	Specification
Nominal Frequency	16.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40C to +85C
Operating Temperature Range	-20C to +75C
Frequency Stability over Operating Temperature	+/- 10 ppm (referred to the value at 25C)
Frequency Make Tolerance (FL)	+/- 10 ppm @ 25C +/- 3C
Equivalent Series Resistance (ESR)	80 max.
Nominal Drive Level	50uW typical and 200uW max
Shunt Capacitance (Co)	2.0 pF max
Load Capacitance (CL)	9 pF
Aging	+/-2ppm/year
Insulation Resistance	500 M min./DC 100V
Marking	Laser Marking
Unit Weight	0.017+/-0.005 g

Mechanical Dimensions (mm): Base

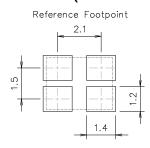


	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND





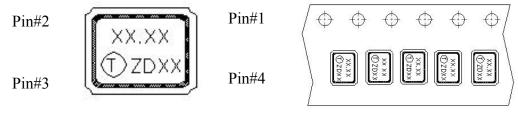
Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (16.00)

Line 2: TST Logo + Crystal Product Code + Date Code + Traceability code (1 or 2 letters, underline or no underline)



The inner vision of Pin#1, Pin#4 side is XTAL blank mounting pad.

TST DCCRelease document

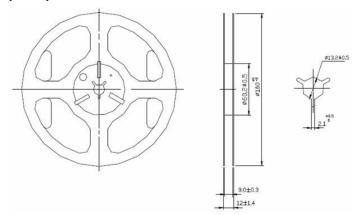
Product Code Table

*	2021	2022	2023	2024
Year	2025	2026	2027	2028
	2029	2030	2031	2032
Product Code	Z	Z	Z	<u>Z</u>

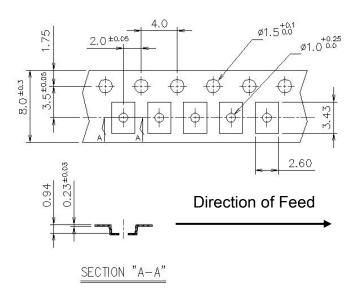
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	Е	F	G	Н	I	J	K	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	0	Р	Q	R	S	Т	U	V	W	Х	Υ	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
а	b	С	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	р	q	r	s	t	u	V	w	х	у	z

Reel Dimensions (mm):



Tape Dimensions (mm):



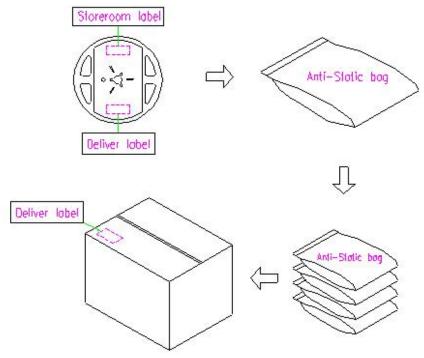
[NOTE]

- 1 UNIT: mm.
- 2 UNLESS OTHERWISE SPECIFIED TOLERANCEON DIM. +/-0.1mm.
- 3 MATERIAL: CONDUCTIVE POLYSTYRENE.
- 4 COLOR: BLACK.

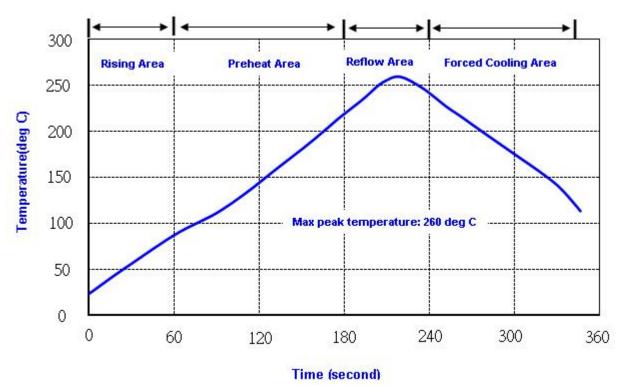
5 10 PITCHES CUMULATIVETOLERANCE +/-0.2mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

Test name	Test process / method	Reference standard						
Mechanical characteristics								
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)						
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202G method 204						
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213						
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002						
Environmental c	haracteristics							
Thermal Shock	Heat cycle conditions -40 °C (30min) ←→ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8						
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103						
Dry heat (Aging test)	Temperature : 125 ± 2 °C Duration : 168 hours	MIL-STD 202G method 108A						
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 °C Duration : 96 hours	IEC 60068-2-1						